



S/N 10/673,605

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	Kum Foo Leong et al.	Examiner:	Nitin Parekh
Serial No.:	10/673,605	Group Art Unit:	2811
Filed:	September 29, 2003	Docket No:	884.A68US1
Title	DIFFUSION BARRIER LAYER FOR LEAD FREE PACKAGE SUBSTRATE		
Assignee:	Intel Corporation	Customer No:	21186

PETITION FOR A ONE-MONTH EXTENSION OF TIME

MS RCE
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

In accordance with the provision of 37 CFR § 1.136(a), it is respectfully requested that a one-month extension of time be granted in which to respond to the Final Rejection mailed December 21, 2004, said period of response being extended from March 21, 2005 to April 21, 2005.

**Our check in the amount of \$120.00 is enclosed to cover the required extension fee.
Please charge any additional fees or credit overpayment to deposit Account No. 19-0743.**

Respectfully Submitted

KUM FOO LEONG ET AL.

By their Representatives,

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Date: 4/21/05

By: Richard E. Billion

Richard E. Billion
Reg. No: 32,836

CERTIFICATE UNDER 37 CFR § 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: MS RCE, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this 21st day of April 2005.

Name: Amy Moriarty

Signature: [Signature]

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